Product data sheet

1. General description

Ultrafast power diode in a 2-leads TO-220 plastic package.

2. Features and benefits

- · Low forward voltage drop
- Low leakage current
- · Soft reverse recovery characteristics
- · High thermal cycling performance

3. Applications

- Home appliance power supply
- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter Conditions | | Values | | | | Unit |
|-------------------------|-------------------------------------|---|-------------|---|------|------|------|
| Absolute maximum rating | | | | | | | |
| V_{RRM} | repetitive peak reverse voltage | | 600 | | | | V |
| $I_{F(AV)}$ | average forward current | δ = 0.5 ; square-wave pulse; $T_{mb} \le 150$ °C; Fig. 1; Fig. 2; Fig. 3 | 9 | | | А | |
| I _{FRM} | repetitive peak forward current | δ = 0.5 ; t_p = 25 μ s; $T_{mb} \le$ 150 °C; square-wave pulse | 18 | | | Α | |
| I _{FSM} | non-repetitive peak forward current | t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4 | 120 | | | Α | |
| | | t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; | 132 | | | Α | |
| Symbol | Parameter | Conditions | Min Typ Max | | Max | Unit | |
| Static ch | Static characteristics | | | | | | |
| V _F | forward voltage | I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u> | | - | 1.05 | 1.3 | V |
| | | I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u> | | - | 0.9 | 1.1 | V |
| Dynamic | Dynamic characteristics | | | | | | |
| t _{rr} | reverse recovery time | $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 7 | | - | 40 | 75 | ns |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------------------------------|--------------------|--------------------|
| 1 | K | cathode | | K — A 001aaa020 |
| 2 | А | anode | | 00 Taaa020 |
| mb | mb | mounting base; connected to cathode | K A TO-220AB | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | |
|-------------|----------|---|----------|--|--|
| | Name | Description | Version | | |
| BYV29-600P | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 2-leads TO-220AB | TO-220AB | | |

7. Marking

Table 4. Marking codes

| Type number | Marking codes |
|-------------|---------------|
| BYV29-600P | BYV29-600P |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Values | Unit |
|--------------------|-------------------------------------|---|------------|------|
| V_{RRM} | repetitive peak reverse voltage | | 600 | V |
| V_{RWM} | crest working reverse voltage | | 600 | V |
| V_R | reverse voltage | DC | 600 | V |
| I _{F(AV)} | average forward current | δ = 0.5; square-wave pulse; $T_{mb} \le 150$ °C; Fig. 1; Fig. 2; Fig. 3 | 9 | Α |
| I _{FRM} | repetitive peak forward current | $δ = 0.5$; $t_p = 25 \mu s$; $T_{mb} \le 150 °C$; square-wave pulse | 18 | А |
| I _{FSM} | non-repetitive peak forward current | t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4 | 120 | А |
| | | t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; | 132 | Α |
| T _{stg} | storage temperature | | -55 to 175 | °C |
| T _j | junction temperature | | 175 | °C |

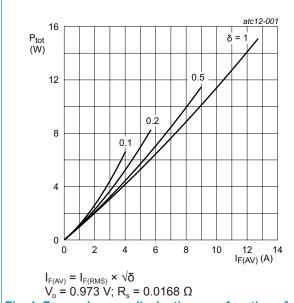
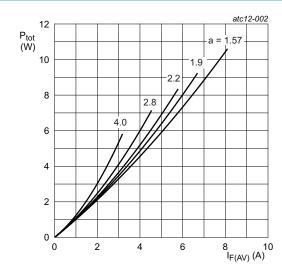


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values



a = form factor = $I_{F(RMS)}/I_{F(AV)}$ Vo = 0.973 V; Rs = 0.0168 Ω

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values

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BYV29-600P

Ultrafast power diode

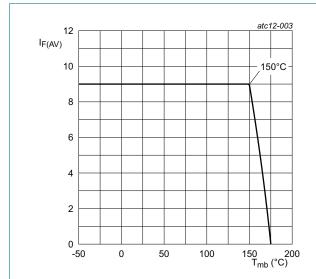


Fig. 3. Forward current as a function of mounting base temperature; maximum values

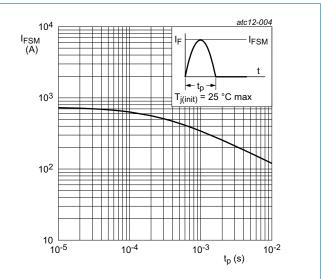
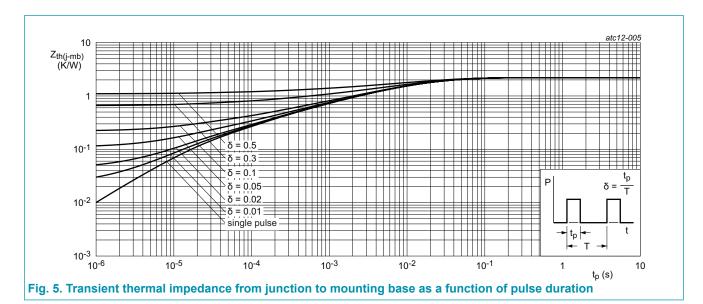


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|--|-------------|-----|-----|-----|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | Fig. 5 | - | - | 2.2 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient free air | in free air | - | 55 | - | K/W |

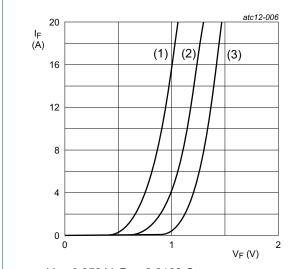


BYV29-600P

10. Characteristics

Table 7. Characteristics

| | | | | | | 1 |
|-----------------|-------------------------------|---|-----|------|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| Static cha | aracteristics | | | | | |
| V _F | forward current | I _F = 8 A; T _j = 25 °C; <u>Fig. 6</u> | | 1.05 | 1.3 | V |
| | | I _F = 8 A; T _j = 150 °C; <u>Fig. 6</u> | - | 0.9 | 1.1 | V |
| I _R | reverse current | V _R = 600 V; T _j = 25 °C | - | - | 10 | μA |
| | | V _R = 600 V; T _j = 150 °C | - | - | 0.4 | mA |
| Dynamic | characteristics | | | | • | • |
| Q_r | reverse charge | $I_F = 1 \text{ A; } V_R = 30 \text{ V; } dI_F/dt = 100 \text{ A/}\mu\text{s;}$ $T_j = 25 \text{ °C; } Fig. 7$ | | 55 | - | nC |
| t _{rr} | reverse recovery time | me $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $I_j = 25 \text{ °C}$; Fig. 7 | | 40 | 75 | ns |
| I _{RM} | peak reverse recovery current | $I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$ | - | 1.9 | - | А |
| | | $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_j = 25 ^{\circ}\text{C}$; Fig. 7 | - | 2.8 | - | А |



 V_o = 0.973 V; R_s = 0.0168 Ω

(1) $T_j = 150$ °C; typical values (2) $T_j = 150$ °C; maximum values

(3) $T_i = 150$ °C; maximum values

Fig. 6. Forward current as a function of forward voltage

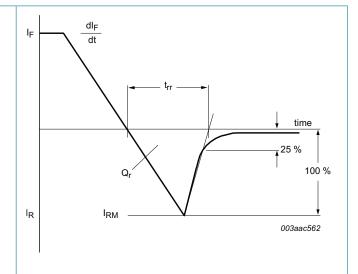
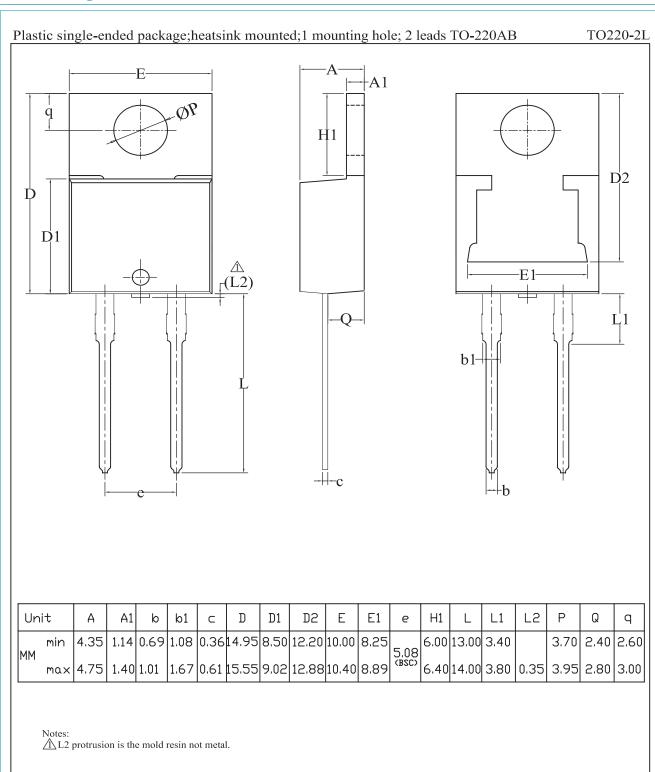


Fig. 7. Reverse recovery definitions; ramp recovery

11. Package outline



12. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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